KMY

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# Specification

(Reference)

Title: FIXED THICK FILM CHIP RESISTORS;

**RECTANGULAR TYPE & HIGH OHM** 

Style: RHC16,20

# **RoHS COMPLIANCE ITEM**

Product specification contained in this specification are subject to change at any time without notice If you have any questions or a Purchasing Specification for any quality Agreement is necessary, please contact our sales staff.



Issue Dept.: Research & Development Department Hokkaido Research Center

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#### 1. Scope

1.1 This specification covers the detail requirements for fixed thick film chip resistors; rectangular type & high ohm, style of RHC16,20.

### 1.2 Applicable documents

JIS C 5201: 1994, JIS C 5202: 1990

#### 2. Classification

Type designation shall be the following form.

(Example) RHC 20 10G0 M TP

1 2 3 4 5

Style

1 Fixed thick film chip resistors; rectangular type & high ohm

2 Size

3 Rated resistance Example;  $10G0 \rightarrow 10G\Omega$ 

4 Tolerance on rated resistance

5 Packaging form

# 3. Rating

3.1 The ratings shall be in accordance with Table-1.

#### Table-1

Style

Style	Rated voltage (V)	Temperature coefficient of resistance (10 <sup>-6</sup> /°C)	Rated resistance range (Ω)	Tolerance on rated resistance	Preferred number series for resistors	Isolation voltage (V)
RHC16			100M~270M	J(±5%)		
		0~-2,000	100M~4G	K(±10%)		
	15		100M~150G	M(±20%), N(±30%), H(±50%)	E12	100
RHC20	13	±2,000	100M~1G	J(±5%), K(±10%)		100
			100M~10G	M(±20%), N(±30%), H(±50%)		
		±4,000		100G~150G	1VI(±20 /0), 14(±30 /0), 1 I(±30 /0)	

Style	Working temperature range(°C)
RHC16	<i>–</i> 55∼+155
RHC20	<i>–</i> 55∼+125

#### 3.2 Derating

The derated values of load at temperature in excess of 70 °C shall be as indicated by the following curve.

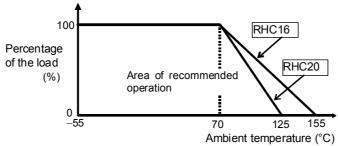


Figure-1 Derating curve

#### 4. Packaging form

The standard packaging form shall be in accordance with Table-2.

Table-2

Symbol	Packaging form		Standard packaging quantity / units
В	Bulk (loose packa	1,000 pcs.	
TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.

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#### 5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-3.

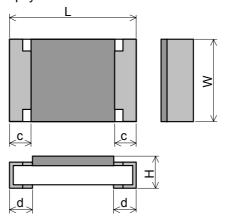


Figure 2

Table-3					
Style	L	W	Н	С	d
RHC16	1.6±0.1	0.8 +0.15 -0.05	0.45±0.10	0.3±0.1	0.3±0.1
RHC20	2.0±0.1	1.25±0.10	0.55±0.10	0.4±0.2	0.4±0.2

## 5.2 Net weight (Reference)

Style	Net weight(mg)	
RHC16	2	
RHC20	5	

# 6. Performance

6.1 The standard condition for tests shall be in accordance with Sub-clause 3, JIS C 5202: 1990.

6.2 The performance shall be satisfied in Table-4.

Table-4(1)

Table 4(1)						
No.	Test items	Condition of test (JIS C 5202)	Performance requirements			
1	DC resistance	Sub-clause 5.1	Within the specified tolerance of rated			
		Measuring voltage: 15 V	resistance.			
2	Temperature	Sub-clause 5.2	See table–1.			
	characteristics of resistance	Test condition: 5 °C / 35 °C				
3	Voltage coefficient	Sub-clause 5.3	RHC16			
		Measuring voltage: 5 V / 15 V	100MΩ≤R<100GΩ: Within ±1 %/V			
			100GΩ≤R≤150GΩ: Within ±2 %/V			
			RHC20			
			100MΩ≤R≤10GΩ: Within 0~-2 %/V			
			100GΩ $\leq$ R $\leq$ 150GΩ: Within $\pm$ 10 %/V			
4	Insulation resistance	Sub-clause 5.6	10 T $\Omega$ min.			
		The resistor shall be fixed on the test fixture as				
		shown in Figure-4.				
		Test potential: 100 Vdc				
		Test period: 1 min.				
5	Capacitance	Measuring voltage: 1 V	1 pF max.			
		Measuring frequency: 10 kHz, 100kHz, 1MHz				

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#### Table 4(2)

	Iable-4(2)						
No.	Test items	Condition of test (JIS C 5202)			Performance requirements		
6	Terminal strength (Pulling test)	mm) sha One side applied t	re (RHC16: $\phi$ 0.4 mm, all be soldered to the cente is fixed and the specific of the other side in the direction in the 10 s $\pm$ 1 s	er of terminal. ed load shall be	Not be peeled off by the pulling force under 5 N. RHC16: 3 N		
7	Substrate bending test	Sub-clause 6.1.4 (1) The resistor shall be mounted on the test substrate as shown in Figure–3. Bending value: 5 mm (Among the fulcrums: 90 mm) Duration: 10 s ± 1 s			No evidence of mechanical damage.		
8	Resistance to soldering heat	Sub-clause 6.10 Test by a piece. Temp. of solder bath: $260  ^{\circ}\text{C} \pm 5  ^{\circ}\text{C}$ Immersion time: $10  \text{s} \pm 1  \text{s}$ After immersion into solder, leaving at the room temp. for 1h or more and then measure the resistance.			RHC16 $100M\Omega \le R \le 10G\Omega: \text{ Within } \pm 1 \text{ %} \\ 10G\Omega < R \le 150G\Omega: \text{ Within } \pm 2 \text{ %} \\ \text{RHC20} \\ 100M\Omega \le R \le 10G\Omega: \text{ Within } \pm 1 \text{ %} \\ 100G\Omega \le R \le 150G\Omega: \text{ Within } \pm 5 \text{ %} \\ \text{No evidence of appearance damage}$		
9	Solderability	Sub-clause 6.11 Test by a piece. Flux: Rosin-Methanol Temp. of solder bath: 235 °C ± 5 °C Immersion time: 2 s ± 0.5 s			The surface of terminal immersed shall be min. of 95% covered with a new coating of solder.		
10	Temperature cycling	Sub-clause 7.4           Test cycle: 5 cycles for duty cycle as specified below.           Step         Temperature (°C)         Time (min)           1         Room temp.         2~3           2         -55±3         30           3         Room temp.         2~3           4         RHC16: 155±2 RHC20: 125±2         30		Time (min)  2~3  30  2~3	RHC16 $100M\Omega \le R \le 10G\Omega: \text{ Within } \pm 1  \%$ $10G\Omega < R \le 150G\Omega: \text{ Within } \pm 2  \%$ $RHC20$ $100M\Omega \le R \le 10G\Omega: \text{ Within } \pm 1  \%$ $100G\Omega \le R \le 150G\Omega: \text{ Within } \pm 5  \%$ No evidence of appearance damage		
11	Humidity	Sub-clause 7.5 Test temp. & relative humidity: $40 ^{\circ}\text{C} \pm 2 ^{\circ}\text{C}  \&  90 \sim 95 ^{\circ}\text{M}$ Test period: 1,000 $^{+48}_{0}$ h			RHC16 $100M\Omega \le R \le 10G\Omega: \text{ Within } \pm 2 \%$ $10G\Omega < R \le 150G\Omega: \text{ Within } \pm 5 \%$ $RHC20$ $100M\Omega \le R \le 10G\Omega: \text{ Within } \pm 2 \%$ $100G\Omega \le R \le 150G\Omega: \text{ Within } \pm 5 \%$ No evidence of appearance damage		
12	Load life	Sub-clause 7.10 Test temp. & relative humidity: 70 °C ± 2 °C Test voltage: Cycle of 1 h 30 min. "ON" and 30 min. "OFF" at dc rated voltage. Test period: 1,000 +48 h			RHC16 $100M\Omega \le R \le 10G\Omega: \text{ Within } \pm 3 \%$ $10G\Omega < R \le 150G\Omega: \text{ Within } \pm 5 \%$ $RHC20$ $100M\Omega \le R \le 10G\Omega: \text{ Within } \pm 3 \%$ $100G\Omega \le R \le 150G\Omega: \text{ Within } \pm 20 \%$ No evidence of appearance damage		

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#### 7. Test substrate

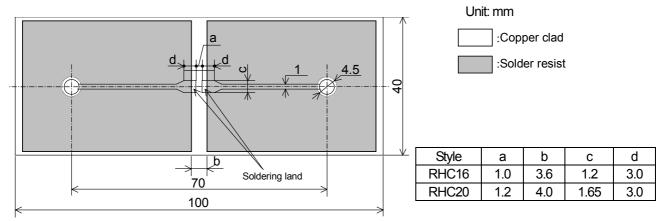
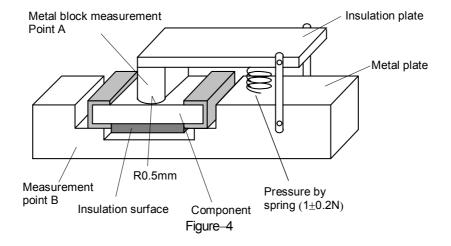


Figure-3 RHC SUBSTRATE BENDING TEST SUBSTRATE

Remark 1). Material: Epoxide woven glass

Thickness: 1.6mm Thickness of copper clad: 0.035mm



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#### 8. Taping

8.1 Applicable documents JIS C 0806-3: 1999, EIAJ ET-7200B: 2003

### 8.2 Taping dimensions

Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-5 and Table-5.

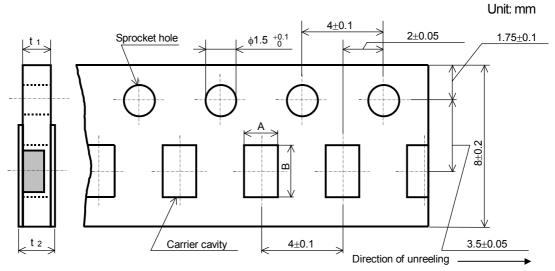
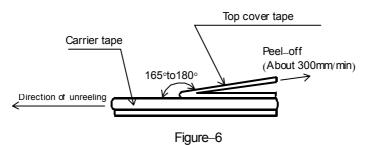


Figure-5 Table-5 Unit: mm Style Α В t<sub>1</sub> t 2 RHC16 1.15±0.15 1.9±0.2 0.6±0.1 0.8max. RHC20 1.65±0.15 2.5±0.2  $0.8 \pm 0.1$ 1.0max.

- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following Figure-6.
- 6). When the tape is bent with the minimum radius for 25 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.

  The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.

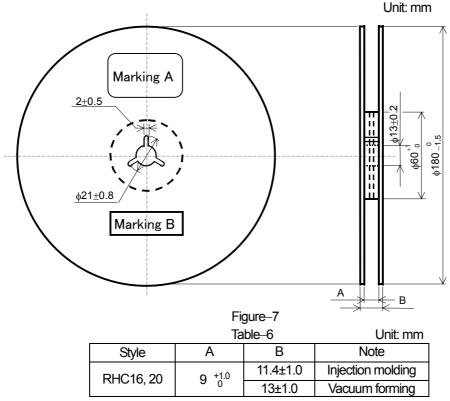


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#### 8.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure–7 and Table–6. Plastic reel (Based on EIAJ ET–7200B)



Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

#### 8.4 Leader and trailer tape.

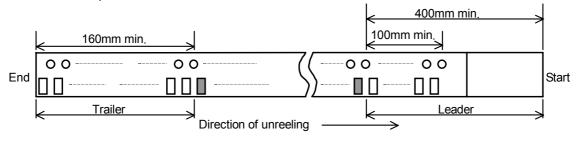


Figure-8

# 9. Marking on package

The label of a minimum package shall be legibly marked with follows.

- 9.1 Marking A
  - (1) Classification (Style, Rated resistance, Tolerance on rated resistance, Packaging form)
  - (2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others
- 9.2 Marking B (KAMAYA Control label)